HMC204C8

GaAs MMIC SMT PASSIVE FREQUENCY DOUBLER, 4 - 8 GHz INPUT

Typical Applications

The HMC204C8 is suitable for:

- Wireless Local Loop
- LMDS, VSAT, and Pt to Pt Radios
- Test Equipment

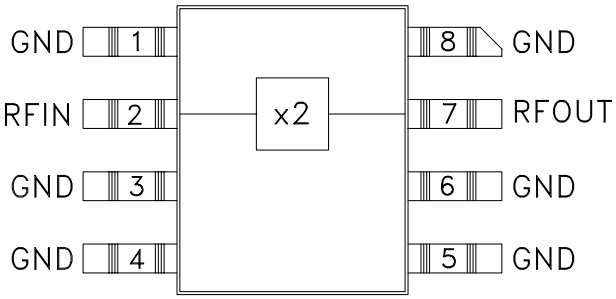
Features

Conversion Loss: 16 dB

Fo, 3Fo, 4Fo Isolation: 40 dB

Passive: No Bias Required

Functional Diagram



General Description

The HMC204C8 is a passive miniature frequency doubler in a non-hermetic surface mount package. Suppression of undesired fundamental and higher order harmonics is 40 dB typical with respect to input signal level. The doubler utilizes the same GaAs Schottky diode/balun technology found in Hittite MMIC mixers. It features small size, no DC bias, and no measurable additive phase noise onto the multiplied signal.

Electrical Specifications, T_A = +25° C, As a Function of Drive Level

	Input = +10 dBm			Input = +13 dBm			Input = +15 dBm			
Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range, Input	5.5 - 7.5			5.0 - 8.0			4.0 - 8.0			GHz
Frequency Range, Output	11.0 - 15.0			10.0 - 16.0			8.0 - 16.0			GHz
Conversion Loss		16	19		16	19		16	19	dB
FO Isolation (with respect to input level)				37	41					dB
3FO Isolation (with respect to input level)				42	46					dB
4FO Isolation (with respect to input level)				35	40					dB

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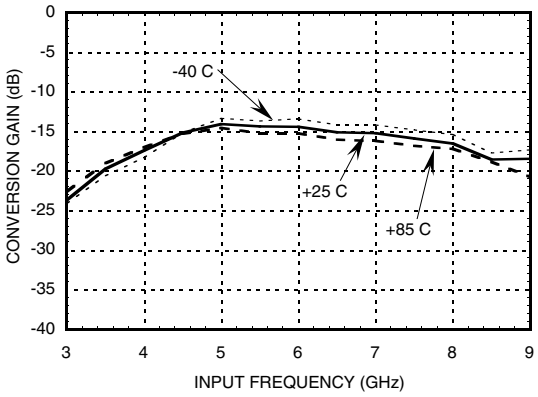
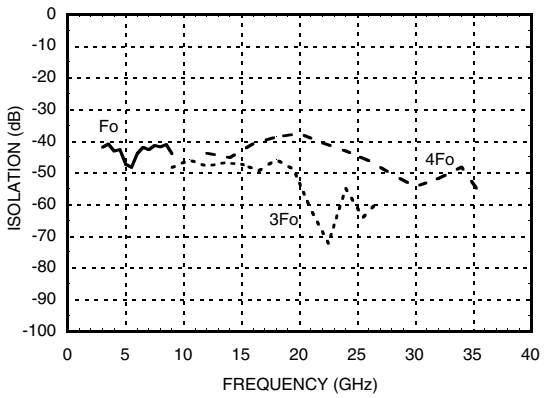
Conversion Gain vs. Temperature @ +15 dBm Drive Level

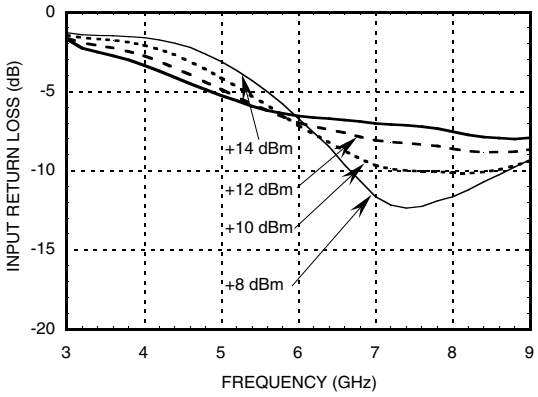


Isolation @ +15 dBm Drive Level*

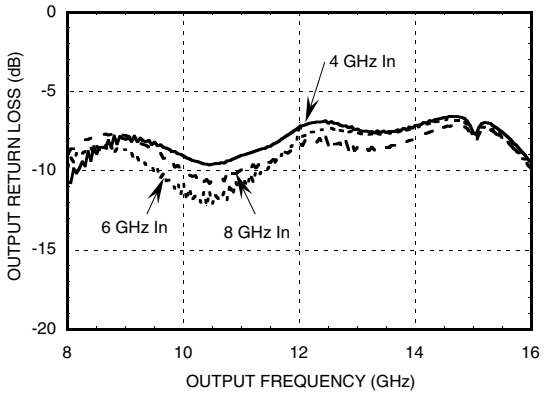


*With respect to input level

Input Return Loss vs. Drive Level



Output Return Loss for Several Input Frequencies



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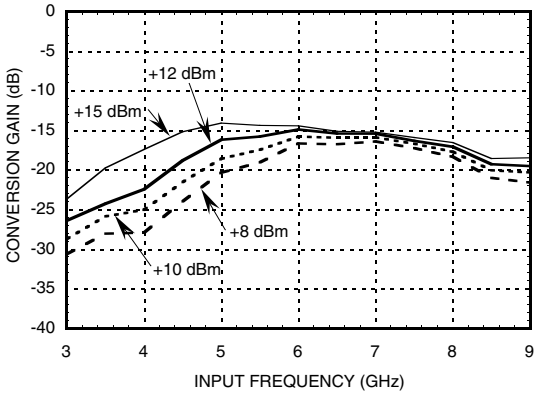
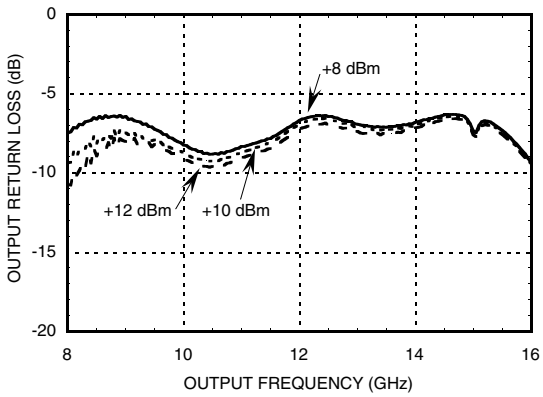
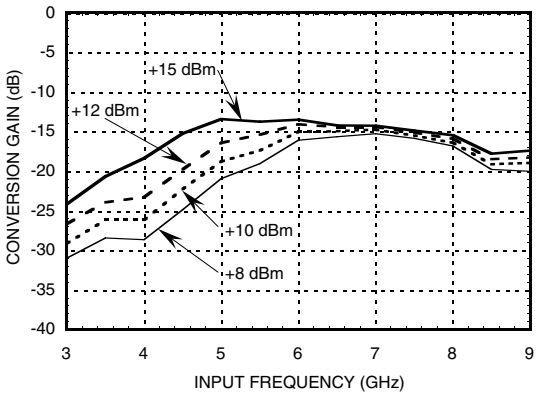
Conversion Gain @ 25 °C vs. Drive Level



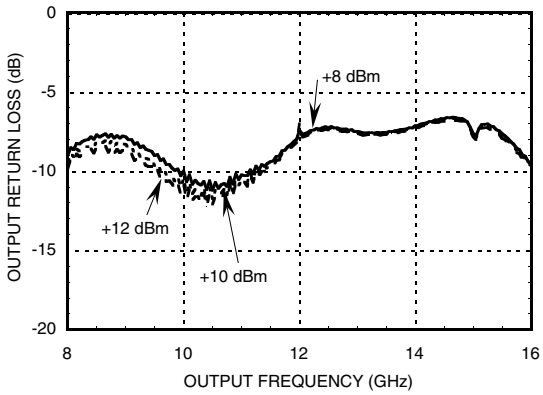
Output Return Loss with 4 GHz Input



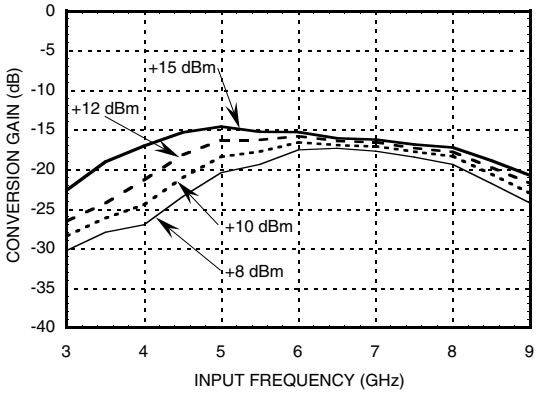
Conversion Gain @ -40 °C vs. Drive Level



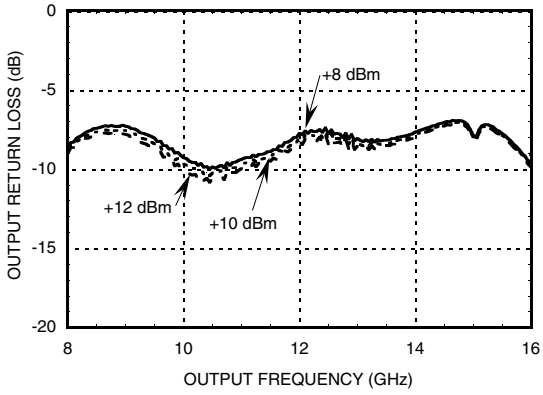
Output Return Loss with 6 GHz Input



Conversion Gain @ +85 °C vs. Drive Level



Output Return Loss with 8 GHz Input

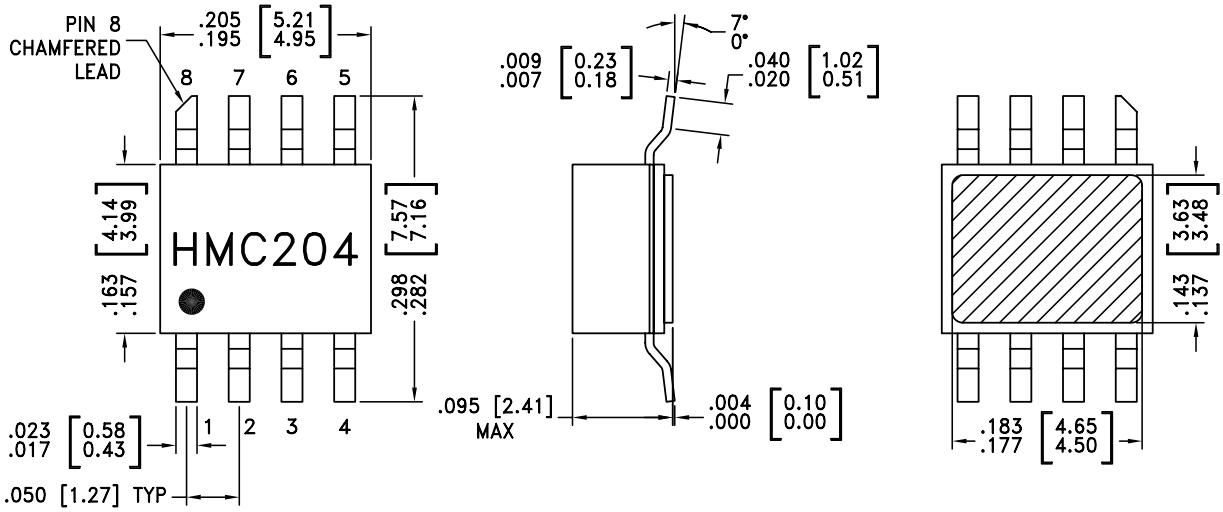


For price, delivery, and to place orders, please contact Hittite Microwave Corporation:
12 Elizabeth Drive, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373
Order Online at www.hittite.com

Absolute Maximum Ratings

Input Drive	+27 dBm
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

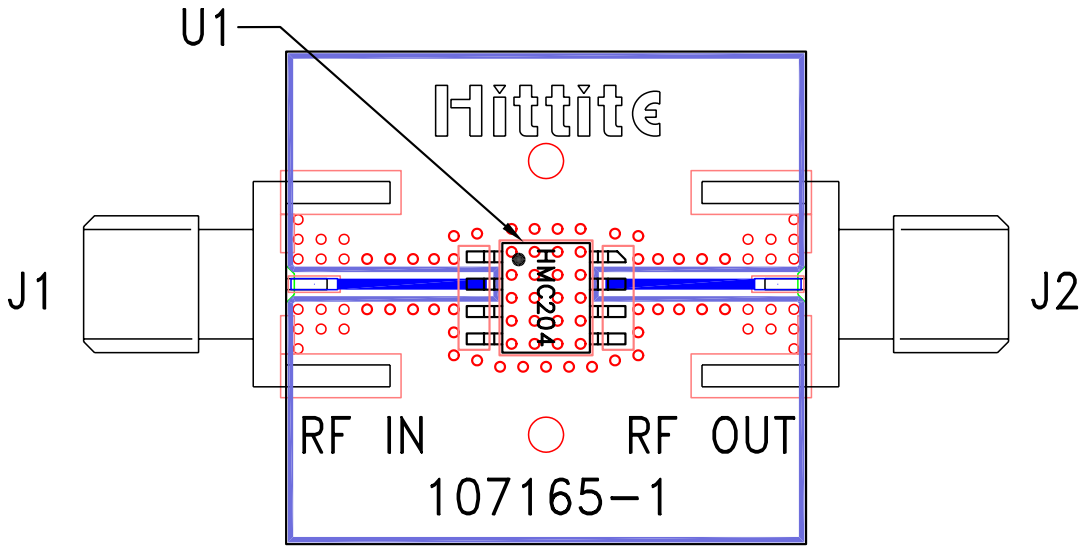
Outline Drawing



NOTES:

1. PACKAGE BODY MATERIAL: WHITE ALUMINA 92%
2. LEAD, PACKAGE BOTTOM MATERIAL: COPPER
3. PLATING: ELECTROLYTIC GOLD 100 - 200 MICROINCHES OVER ELECTROLYTIC NICKEL 100 TO 200 MICROINCHES.
4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
5. PACKAGE LENGTH AND WIDTH DIMENSIONS DO NOT INCLUDE LID SEAL PROTRUSION .005 PER SIDE.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB PF GROUND.

Evaluation PCB



The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.

List of Materials

Item	Description
J1, J2	PC Mount SMA Connector
U1	HMC204C8, Doubler
PCB*	107165 Eval Board
* Circuit Board Material: Rogers 4350	

Notes: